



# **Small Signal Zener Diode**

### **General Description**

These diodes small signal Zener diodes, fabricated in planar technology. Miniature surface mount package is excellent for hand-held and portable applications where is space is limited.

#### **Features and Benefits**

- Silicon epitaxial planar diode
- Low Zener impedance and low leakage current
- Standard Zener voltage tolerance is 4.3%.
- Full lead (Pb)-free device and RoHS compliant device
- · Available in "Green" device











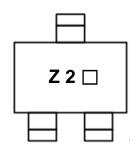
#### **Applications**

Voltage regulator

### **Ordering Information**

Part Number	Marking Code	Package	Packaging
SDZ5V1	Z 2 🗆	SOT-23	Tape & Reel

### **Marking Information**



Z 2 = Specific Device Code

☐ = Year & Week Code Marking

### **Pinning Information**

Pin	Description	Simplified Outline	Graphic Symbol
1	Anode	<u> </u>	3
2	Not Connected		*
3	Cathode	1	

# **Absolute Maximum Ratings** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Power dissipation 1)	$P_{D}$	200	mW
Operating junction temperature	TJ	150	°C
Storage temperature range	T <sub>stg</sub>	-55°C to +150°C	°C

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## **Thermal Characteristics** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient 1)	R <sub>th(j-a)</sub>	625	°C/W

<sup>1)</sup> Device mounted on FR-4 board with recommended pad layout.

## **Electrical Characteristics** (T<sub>amb</sub>=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Zener voltage	V <sub>Z</sub>	I <sub>Z</sub> =5mA	4.88		5.32	V
Dynamic impedance	Z <sub>ZT</sub>	I <sub>Z</sub> =5mA	-	-	70	Ω
KNEE dynamic impedance	Z <sub>ZK</sub>	I <sub>Z</sub> =0.25mA	-	-	2050	Ω
Reverse leakage current	I <sub>R</sub>	V <sub>R</sub> =2V	-	-	2	μА

### **Rating and Characteristic Curves**

Fig. 1) Typical Zener Characteristics

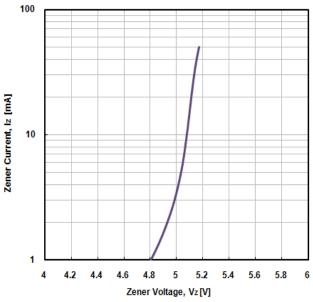


Fig. 3) Typical Capacitance Characteristics

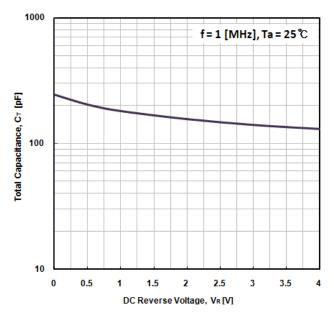


Fig. 2) Typical Forward Characteristics

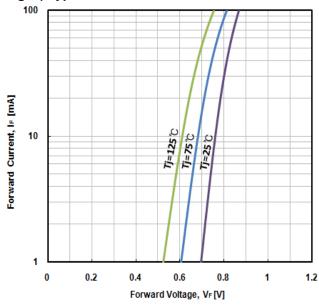
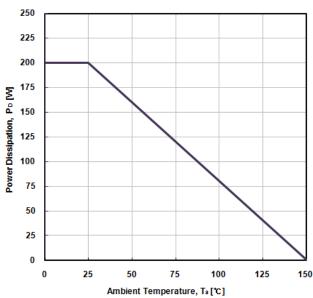
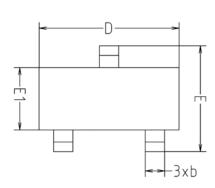
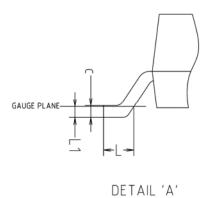


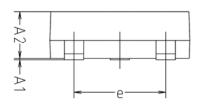
Fig. 4) Power Dissipation vs. Ambient Temperature



# **Package Outline Dimensions**



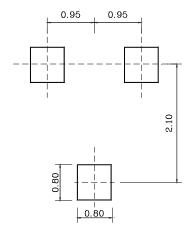






SYMBOL	MILLIMETERS			NOTE
STITIBUL	MINIMUM	NOMINAL	MAXIMUM	NOTE
A1	0.00	-	0.10	
A2	0.82	-	1.02	
Ь	0.39	0.42	0.45	
С	0.09	0.12	0.15	
D	2.80	2.90	3.00	
Е	2.20	2.40	2.60	
E1	1.20	1.30	1.40	
е	1.90BSC			
L	0.20	-	-	
L1	0.12BSC			

### **X** Recommend PCB solder land (Unit : mm)



SDZ5V1

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